# RENESAS HD74LVC1G32

2-input OR Gate

REJ03D0010-0300Z Rev.3.00 Jul. 01.2004

# Description

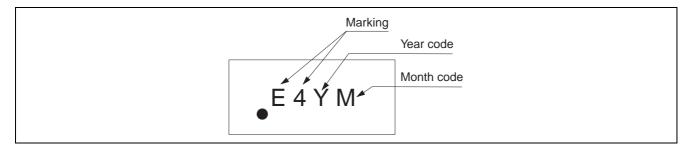
The HD74LVC1G32 has two–input OR gate in a 5-pin package. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

## Features

- The basic gate function is lined up as renesas uni logic series.
- Supply voltage range: 1.65 to 5.5 V Operating temperature range: -40 to +85°C
- All inputs:  $V_{IH}$  (Max.) = 5.5 V (@V<sub>CC</sub> = 0 V to 5.5 V)
- All outputs:  $V_O(Max.) = 5.5 V (@V_{CC} = 0 V)$ • Output current:  $\pm 4 \text{ mA} (@V_{CC} = 1.65 V)$ 
  - $\begin{array}{l} \pm 8 \text{ mA} (@V_{CC} = 2.3 \text{ V}) \\ \pm 24 \text{ mA} (@V_{CC} = 3.0 \text{ V}) \\ \pm 32 \text{ mA} (@V_{CC} = 4.5 \text{ V}) \end{array}$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LVC1G32CPE	WCSP-5 pin	TBS-5V	СР	E (3,000 pcs/reel)
HD74LVC1G32CLE		TBS-5AV	CL	

# Article indication





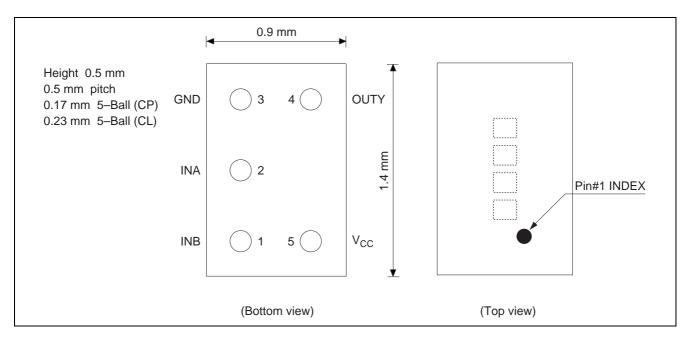
# **Function Table**

Inp		
A	Output Y	
L	L	L
н	L	Н
L	Н	Н
Н	Н	Н

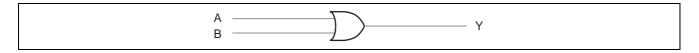
H: High level

L: Low level

# **Pin Arrangement**



# Logic Diagram





# **Absolute Maximum Ratings**

ltem	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V <sub>CC</sub>	–0.5 to 6.5	V	
Input voltage range *1	VI	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V <sub>CC</sub> +0.5	V	Output : H or L
		-0.5 to 6.5		V <sub>CC</sub> : OFF
Input clamp current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>ОК</sub>	-50	mA	V <sub>0</sub> < 0
Continuous output current	lo	±50	mA	$V_{\rm O} = 0$ to $V_{\rm CC}$
Continuous current through V <sub>CC</sub> or GND	I <sub>CC</sub> or I <sub>GND</sub>	±100	mA	
Package Thermal impedance	$\theta_{ja}$	154	°C/W	СР
		132		CL
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

# **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	V <sub>cc</sub>	V	
Output current	I <sub>OL</sub>	_	4	mA	V <sub>CC</sub> = 1.65 V
		_	8		V <sub>CC</sub> = 2.3 V
		_	16		$V_{CC} = 3.0 \text{ V}$
		_	24		
		_	32		V <sub>CC</sub> = 4.5 V
	I <sub>OH</sub>	_	-4		V <sub>CC</sub> = 1.65 V
		_	-8		V <sub>CC</sub> = 2.3 V
		_	-16		V <sub>CC</sub> = 3.0 V
		_	-24		
		_	-32		$V_{CC} = 4.5 V$
Input transition rise or fall rate	Δt / Δν	0	20	ns / V	V <sub>CC</sub> = 1.65 to 1.95 V, 2.3 to 2.7 V
		0	10		$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$
		0	5		V <sub>CC</sub> = 4.5 to 5.5 V
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.



# **Electrical Characteristics**

Ta = -40 to  $85^{\circ}C$ 

ltem	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Unit	Test condition
Input voltage	V <sub>IH</sub>	1.65 to 1.95	V <sub>CC</sub> ×0.65	_	_	V	
		2.3 to 2.7	1.7	_	_		
		3.0 to 3.6	2.0		_		
		4.5 to 5.5	V <sub>CC</sub> ×0.7	_	_		
	V <sub>IL</sub>	1.65 to 1.95	—	_	V <sub>CC</sub> ×0.35		
		2.3 to 2.7	_		0.7		
		3.0 to 3.6	—	_	0.8		
		4.5 to 5.5			V <sub>CC</sub> ×0.3		
Output voltage	V <sub>OH</sub>	Min to Max	V <sub>CC</sub> -0.1	—		V	I <sub>OH</sub> = −100 μA
		1.65	1.2		_		I <sub>OH</sub> = -4 mA
		2.3	1.9		_		I <sub>OH</sub> = -8 mA
		3.0	2.4		_		I <sub>OH</sub> = -16 mA
			2.3		_		I <sub>OH</sub> = -24 mA
		4.5	3.8		_		I <sub>OH</sub> = -32 mA
	V <sub>OL</sub>	Min to Max	_		0.1		I <sub>OL</sub> = 100 μA
		1.65	—	_	0.45		I <sub>OL</sub> = 4 mA
		2.3	—	_	0.3		I <sub>OL</sub> = 8 mA
		3.0	_		0.4		I <sub>OL</sub> = 16 mA
			_		0.55		I <sub>OL</sub> = 24 mA
		4.5	_	_	0.55		I <sub>OL</sub> = 32 mA
nput current	I <sub>IN</sub>	0 to 5.5	_		±5	μA	$V_{IN} = 5.5 V \text{ or GND}$
Quiescent	Icc	5.5		—	10	μA	$V_{IN} = V_{CC}$ or GND, $I_0 = 0$
supply current	$\Delta I_{CC}$	3 to 5.5		—	500		One input at V <sub>CC</sub> –0.6 V,
							Other input at V <sub>CC</sub> or GNI
Output leakage current	I <sub>OFF</sub>	0	_	-	±10	μA	$V_{IN}$ or $V_O = 0$ to 5.5 V
nput capacitance	CIN	3.3	_	4.0	<b>—</b>	pF	$V_{IN} = V_{CC}$ or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.



# **Switching Characteristics**

 $V_{CC} = 1.8 \pm 0.15 \text{ V}$ 

						• =	1.0 ± 0.15
		Ta = -40	) to 85°C			FROM	то
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	1.9	7.2	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Y
	t <sub>PHL</sub>	2.8	8.0		$C_L = 30 \text{ pF}, R_L = 1.0 \text{ k}\Omega$		

 $V_{CC}=2.5\pm0.2~V$ 

		Ta = -40	) to 85°C			FROM	то
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	0.8	4.4	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Y
	t <sub>PHL</sub>	1.2	5.5		$C_{L} = 30 \text{ pF}, R_{L} = 500 \Omega$		

 $V_{CC}=3.3\pm0.3~V$ 

						·ιι	- 5.5 ± 0.5
		Ta = -40	) to 85°C			FROM	то
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	0.9	3.6	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Y
	t <sub>PHL</sub>	1.1	4.5		$C_L = 50 \text{ pF}, \text{ R}_L = 500 \Omega$		

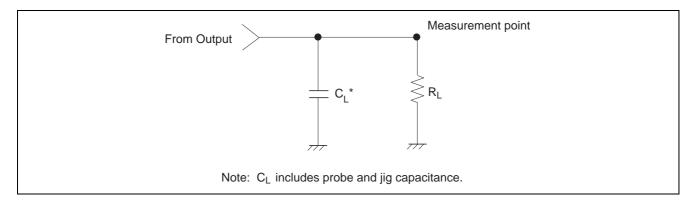
 $V_{CC}=5.0\pm0.5~V$ 

		Ta = -40	) to 85°C			FROM	то
Item	Symbol	Min	Max	Unit	Test Conditions	(Input)	(Output)
Propagation delay time	t <sub>PLH</sub>	0.8	3.4	ns	$C_L = 15 \text{ pF}, R_L = 1 \text{ M}\Omega$	A or B	Y
	t <sub>PHL</sub>	1.0	4.0		$C_L = 50 \text{ pF}, \text{ R}_L = 500 \Omega$		

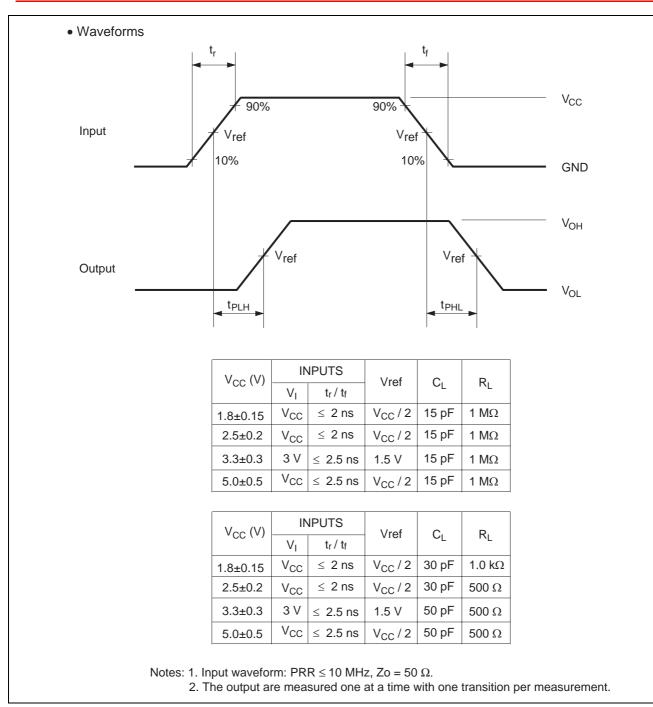
# **Operating Characteristics**

				Ta = 25°C		Unit	Test Conditions
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max		
Power dissipation capacitance	CPD	1.8	—	20	_	pF	f = 10 MHz
		2.5	—	20	_		
		3.3	—	21			
		5.0	_	22	_	1	

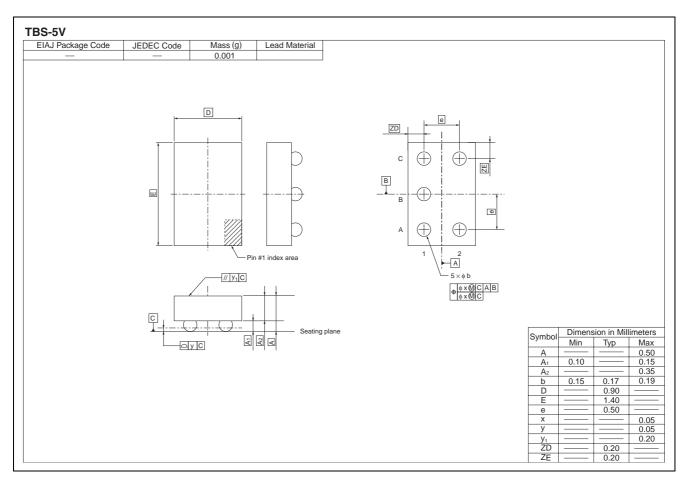
# **Test Circuit**







# **Package Dimensions**





### HD74LVC1G32

EIAJ Package Code	JEDEC Code Mass (g) — 0.001	Lead Material		
		-Pin #1 index area	Symbol A A1 A2 b D E e x y y1 ZD	Dimension in Millimet           Min         Nom         M           —         —         0.           0.155         —         0.           —         —         0.0           0.20         —         0.           —         0.30         —           1.40         —         —           —         0.50         —           —         —         0.           —         —         0.

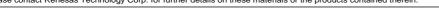


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